

Electronic Patent Application Fee Transmittal**Application Number:**

10546897

Filing Date:

22-Aug-2003

Title of Invention:

SEMICONDUCTOR COMPONENT HAVING THINNED DIE WITH CONTACT BUMPS AND POLYMER LAYERS ON SIX SIDES

First Named Inventor/Applicant Name:

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Attorney Docket Number:

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Utility under 35 USC 111(a) Filing Fees

Description

Fee Code

Quantity

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USD(\$)**Basic Filing:****Pages:****Claims:****Miscellaneous-Filing:****Petition:****Patent-Appeals-and-Interference:****Post-Allowance-and-Post-Issuance:****Extension-of-Time:**

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Request for continued examination	1801	1	810	810
Total in USD (\$)				810